FAIRCHILD SEMICONDUCTOR®

August 2009

SupreMOS™

FCP9N60N / FCPF9N60NT

N-Channel MOSFET

600V, 9A, 0.385Ω

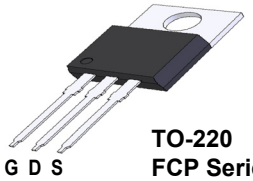
Features

- $R_{DS(on)}$ = 0.33Ω (Typ.)@ V_{GS} = 10V, I_D = 4.5A
- Ultra low gate charge (Typ. Qg = 22nC)
- Low effective output capacitance
- 100% avalanche tested
- RoHS compliant

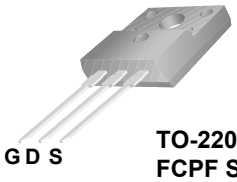
Description

The SupreMOS MOSFET, Fairchild's next generation of high voltage super-junction MOSFETs, employs a deep trench filling process that differentiates it from preceding multi-epi based technologies. By utilizing this advanced technology and precise process control, SupreMOS provides world class Rsp, superior switching performance and ruggedness.

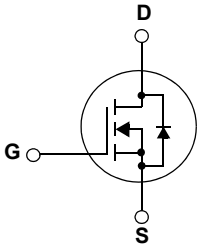
This SupreMOS MOSFET fits the industry's AC-DC SMPS requirements for PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.



TO-220
FCP Series



TO-220F
FCPF Series



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter			FCP9N60N	FCPF9N60NT	Units
V_{DSS}	Drain to Source Voltage			600		V
V_{GSS}	Gate to Source Voltage			±30		V
I_D	Drain Current	-Continuous (T_C = 25°C)		9.0	9.0*	A
		-Continuous (T_C = 100°C)		5.7	5.7*	
I_{DM}	Drain Current	- Pulsed	(Note 1)	27	27*	A
E_{AS}	Single Pulsed Avalanche Energy		(Note 2)	135		mJ
I_{AR}	Avalanche Current			3		A
E_{AR}	Repetitive Avalanche Energy			0.83		mJ
dv/dt	MOSFET dv/dt Ruggedness			100		V/ns
	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns
P_D	Power Dissipation	(T_C = 25°C)		83.3	29.8	W
		- Derate above 25°C		0.67	0.24	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range			-55 to +150		°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCP9N60N	FCPF9N60NT	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.5	4.2	°C/W
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	0.5	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	

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Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCP9N60N	FCP9N60N	TO-220	-	-	50
FCPF9N60NT	FCPF9N60NT	TO-220F	-	-	50

Electrical Characteristics $T_C = 25^oC$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 1mA, V_{GS} = 0V, $T_C = 25^oC$	600	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 1mA, Referenced to 25^oC	-	0.72	-	$V/^oC$
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 480V, V_{GS} = 0V	-	-	10	μA
		V_{DS} = 480V, V_{GS} = 0V, $T_C = 125^oC$	-	-	100	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±30V, V_{DS} = 0V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 250μA	2.0	-	4.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10V, I_D = 4.5A	-	0.33	0.385	Ω
g_{FS}	Forward Transconductance	V_{DS} = 40V, I_D = 4.5A	-	7.5	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 100V, V_{GS} = 0V, f = 1MHz	-	930	1240	pF
C_{oss}	Output Capacitance		-	35	50	pF
C_{rss}	Reverse Transfer Capacitance		-	2	4	pF
C_{oss}	Output Capacitance	V_{DS} = 380V, V_{GS} = 0V, f = 1MHz	-	20	-	pF
C_{oss}eff.	Effective Output Capacitance	V_{DS} = 0V to 480V, V_{GS} = 0V	-	106	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	V_{DS} = 380V, I_D = 4.5A, V_{GS} = 10V (Note 4)	-	22.0	29	nC
Q_{gs}	Gate to Source Gate Charge		-	4.1	-	nC
Q_{gd}	Gate to Drain “Miller” Charge		-	7.1	-	nC
ESR	Equivalent Series Resistance (G-S)	Drain Open		2.9		Ω
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 380V, I_D = 4.5A, R_G = 4.7Ω (Note 4)	-	12.7	35.4	ns
t_r	Turn-On Rise Time		-	8.7	27.4	ns
$t_{d(off)}$	Turn-Off Delay Time		-	36.9	83.8	ns
t_f	Turn-Off Fall Time		-	10.2	30.4	ns
Drain-Source Diode Characteristics						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	9.0	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	27	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0V, I_{SD} = 4.5A	-	-	1.2	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_{SD} = 4.5A, dI_F/dt = 100A/μs	-	213	-	ns
Q_{rr}	Reverse Recovery Charge		-	2.2	-	μC

Notes:
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_{AS} = 3A, R_G = 25Ω, Starting T_J = 25°C
3. $I_{SD} \le$ 9A, di/dt ≤ 200A/μs, V_{DD} = 380V, Starting T_J = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

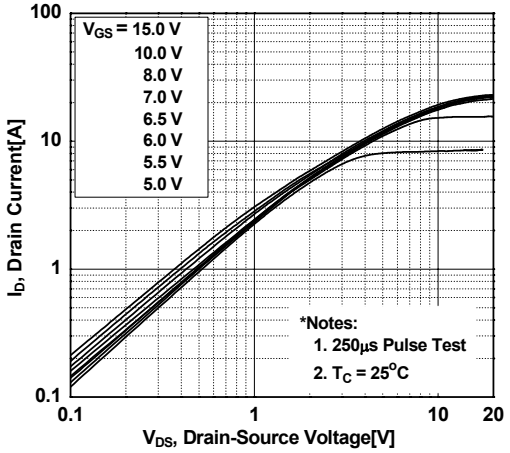


Figure 2. Transfer Characteristics

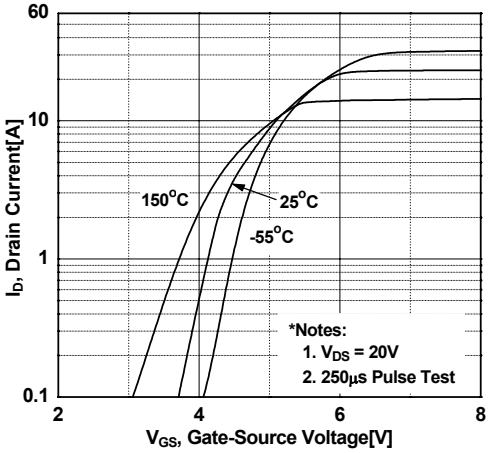


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

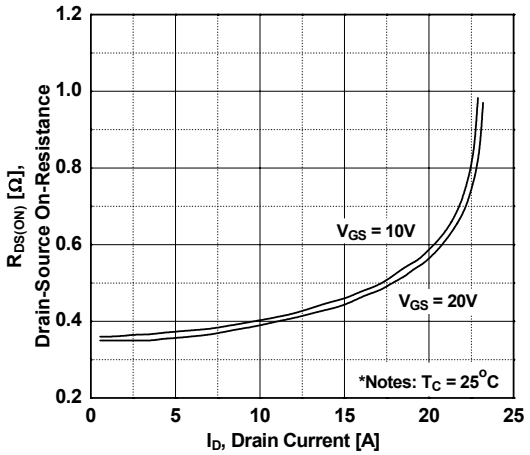


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

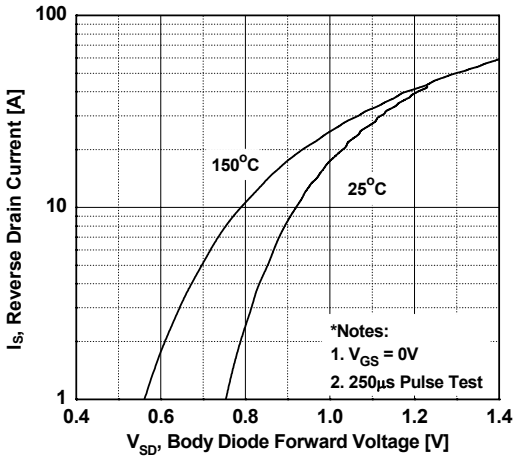


Figure 5. Capacitance Characteristics

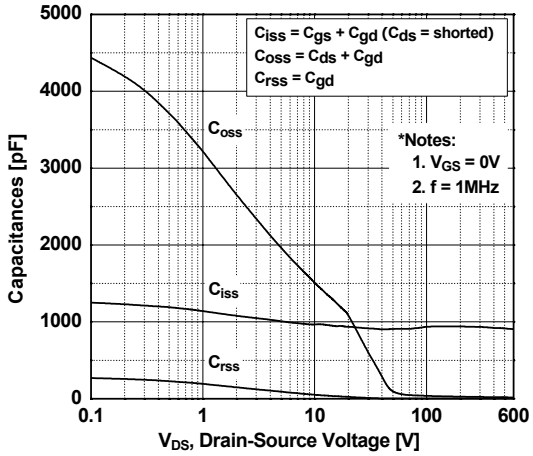
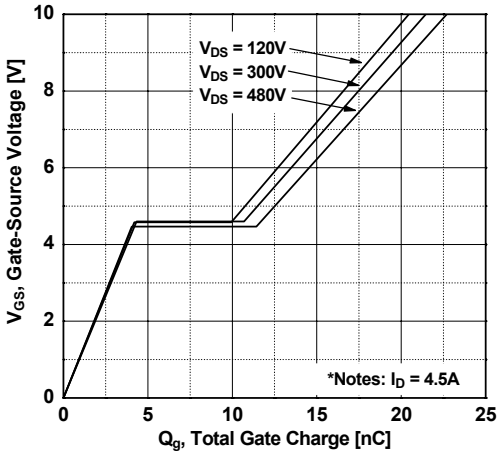


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

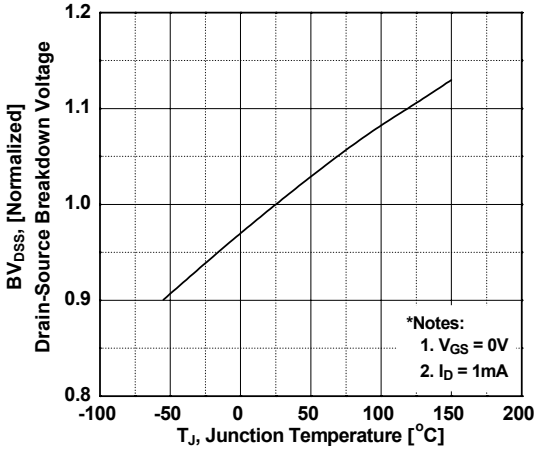


Figure 8. On-Resistance Variation vs. Temperature

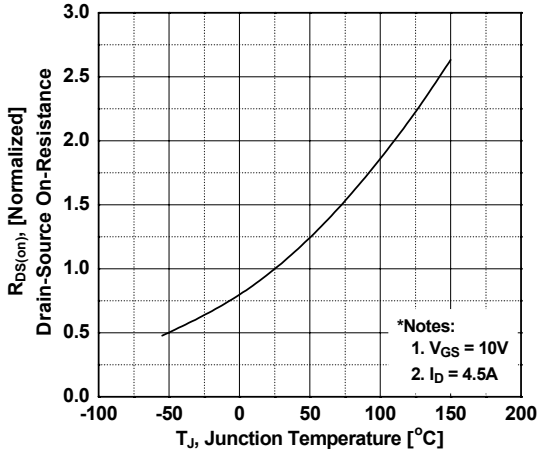


Figure 9. Maximum Safe Operating Area _ FCP9N60N

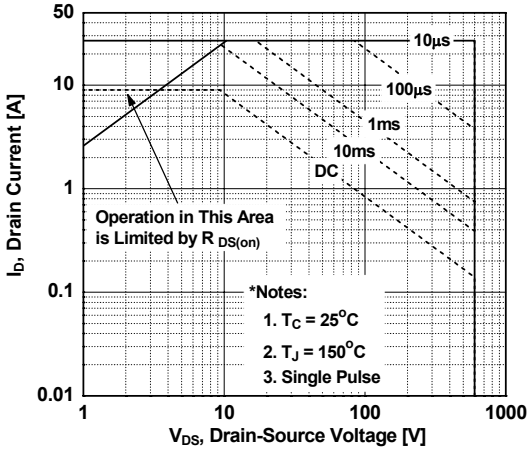


Figure 10. Maximum Safe Operating Area _ FCPF9N60NT

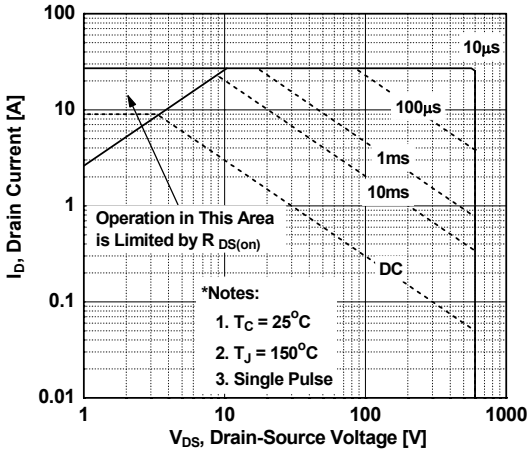
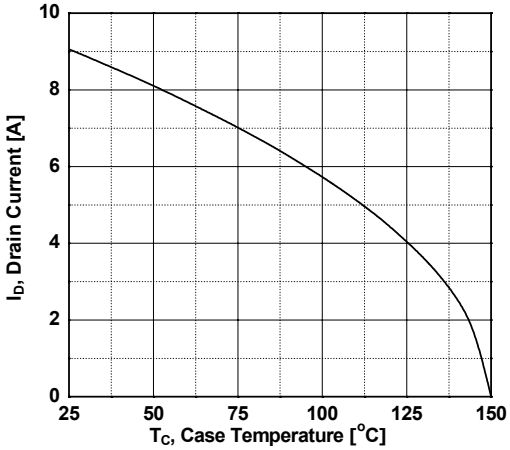


Figure 11. Maximum Drain Current vs. Case Temperature



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve _ FCP9N60N

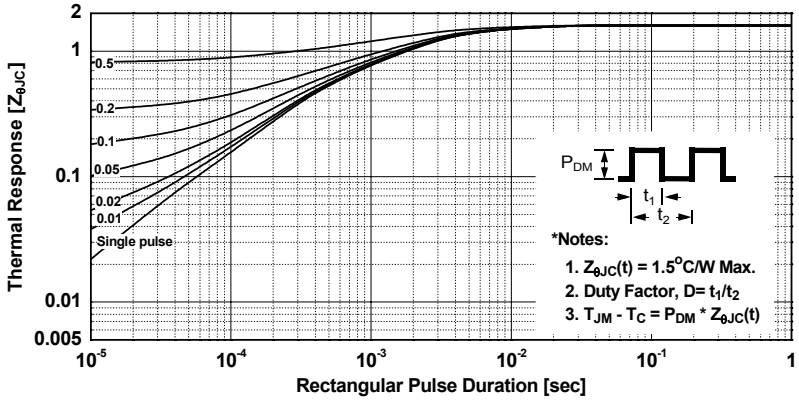
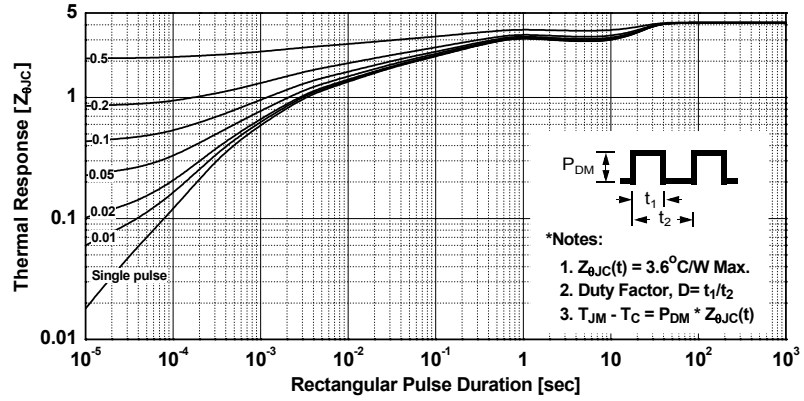
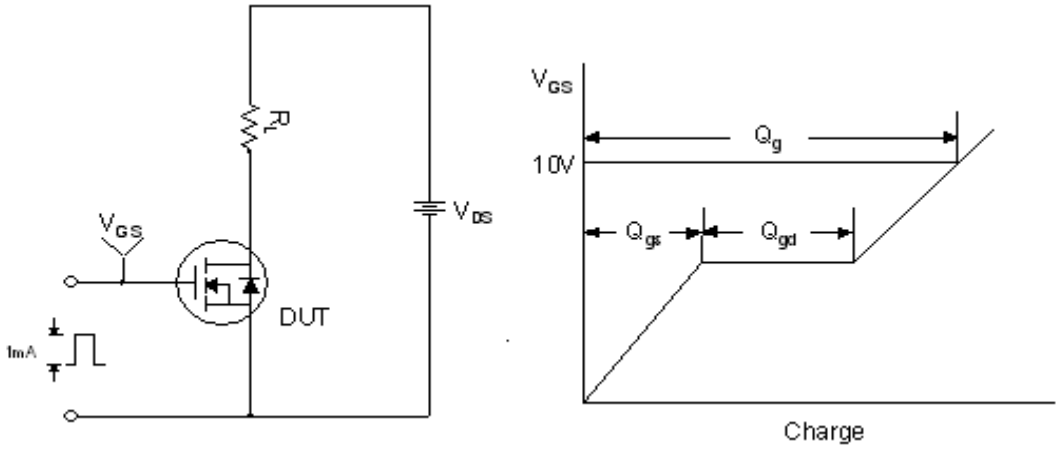


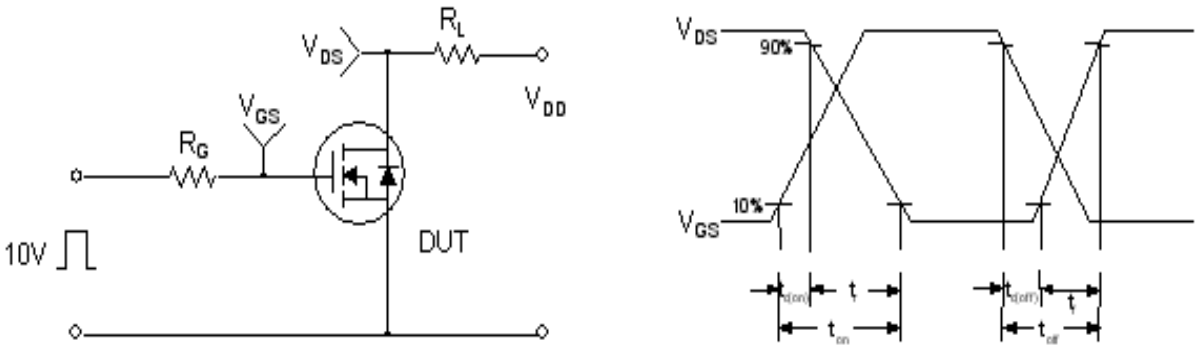
Figure 13. Transient Thermal Response Curve _ FCPF9N60NT



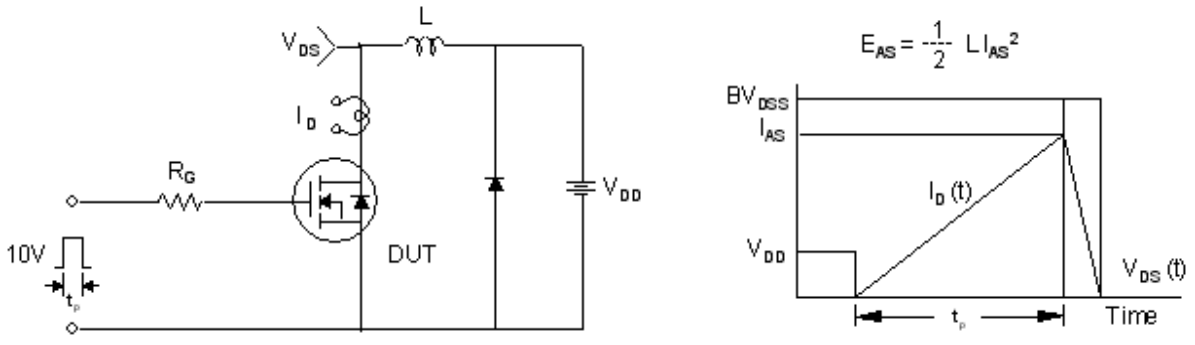
Gate Charge Test Circuit & Waveform



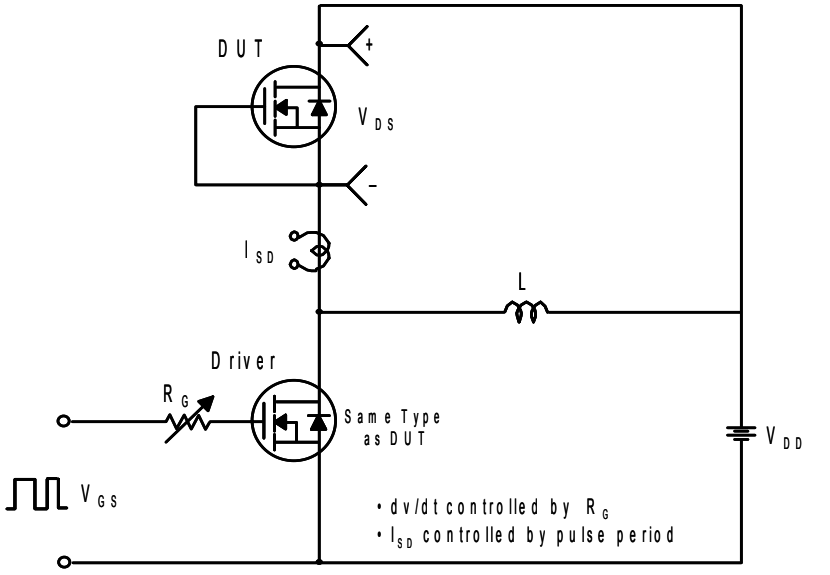
Resistive Switching Test Circuit & Waveforms

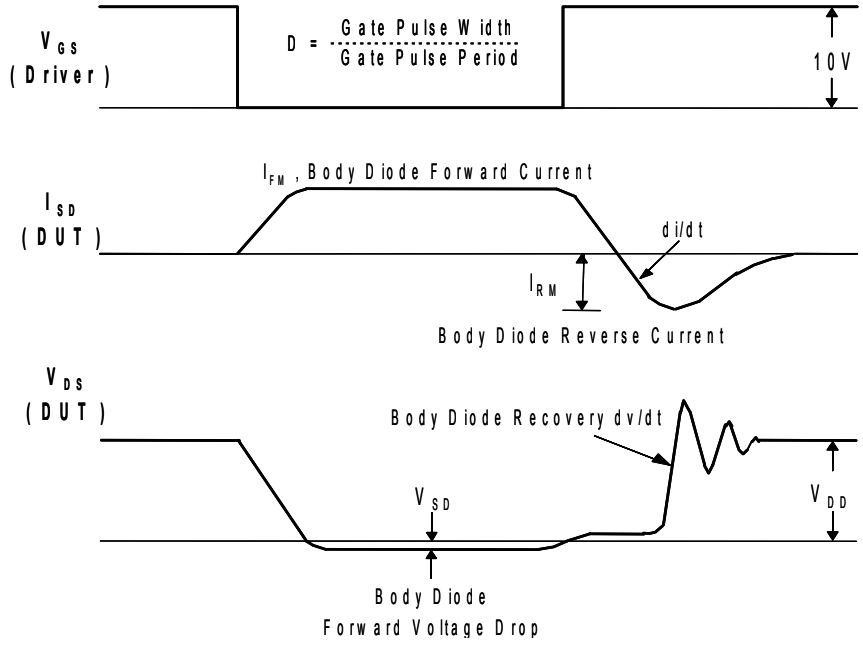


Unclamped Inductive Switching Test Circuit & Waveforms



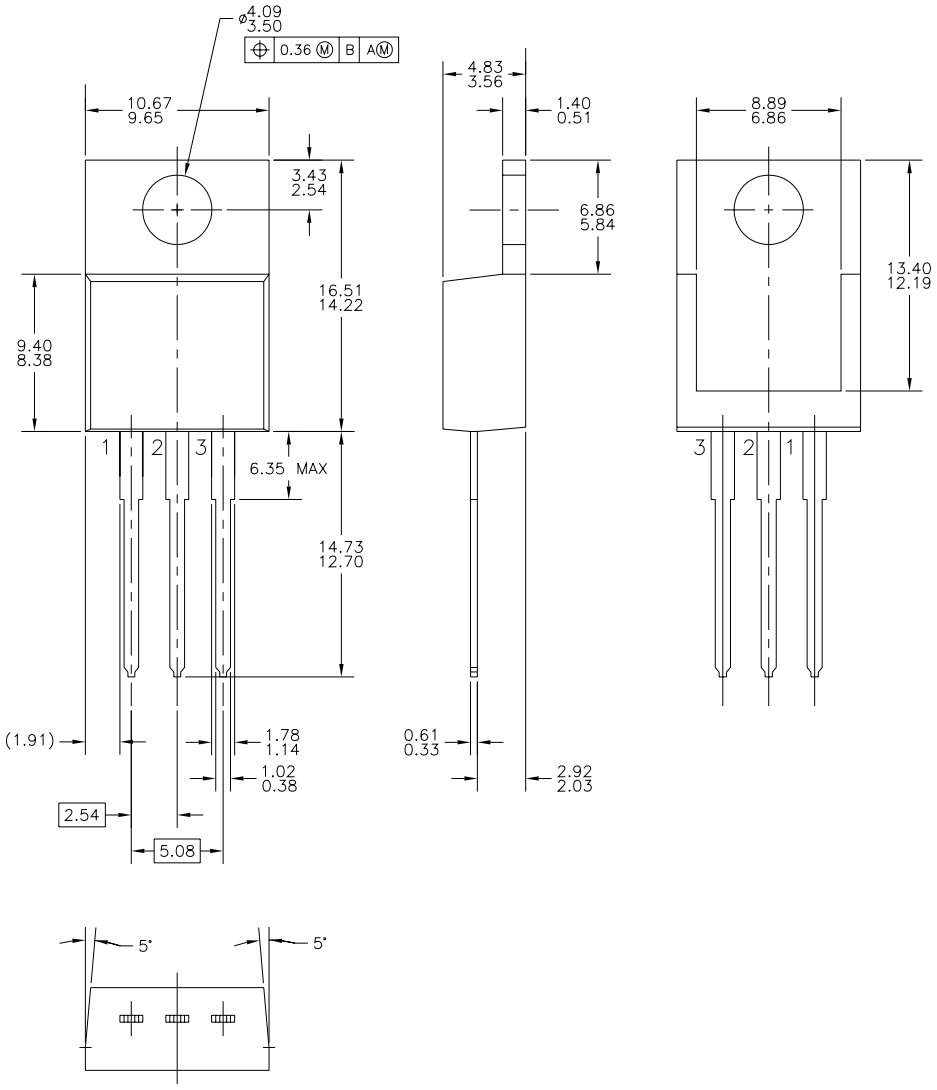
Peak Diode Recovery dv/dt Test Circuit & Waveforms





Mechanical Dimensions

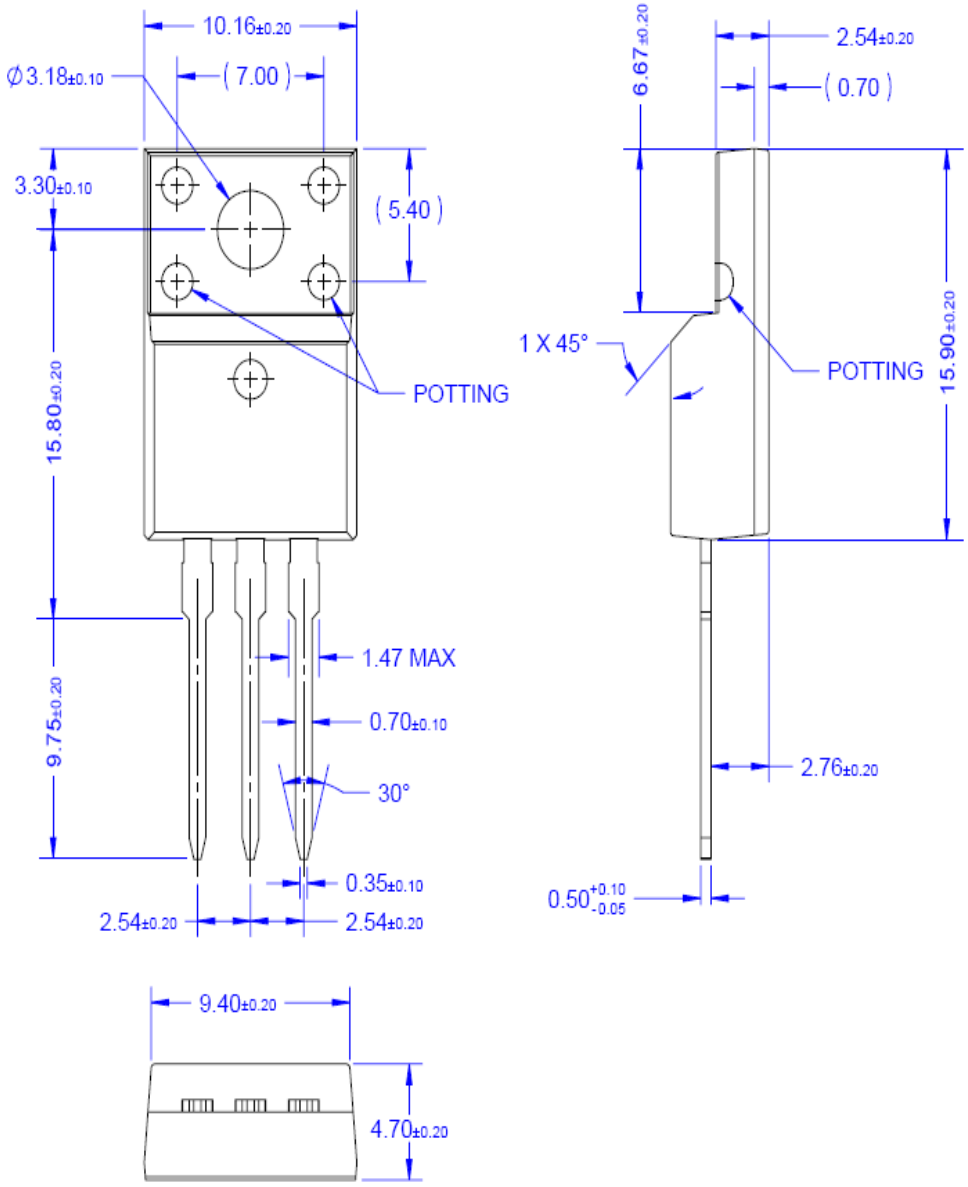
TO-220



Dimensions in Millimeters

Mechanical Dimensions

TO-220F



Dimensions in Millimeters

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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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